

Specification for TFT

AFY240320A1-2.4INTH-C1

Revision M

| А | Orient Display |
|--------|--|
| FY | ТFT Туре |
| 240320 | Resolution 240 x 320 |
| A1 | Serial A1 |
| 2.4 | 2.4", Module Dimension 43.22 x 60.31 x 3.93 mm |
| 1 | IPS Display |
| Ν | Top: -20~+70°C; Tstr: -30~+80°C |
| Т | Transmissive |
| Н | Hight Brightness, 900 cd/m2 |
| С | Capacitive Touch Panel |
| / | White Backlight |
| 1 | Controller <u>ST7789VI</u> Or Compatible; CTP Controller |
| / | ST1633I or Compatible |
| / | RGB/MCU/SPI interface |









REVISION RECORD

| Rev No. | Rev date | Contents | Remarks |
|---------|------------|--|-----------------------|
| 0 | 2019-10-31 | First release | Preliminary |
| Α | 2019-12-18 | CHANGE CTP. IN PAGE OF 6 th . | |
| В | 2020-12-29 | CHANGE SHAPE OF LENS. IN PAGE OF 6 th . | |
| С | 2020-01-03 | CHANGE LENS IN PAGE OF 6 th . | |
| D | 2020-01-13 | CHANGE TP-FPC.IN PAGE OF 6 th . | |
| E | 2020-03-05 | CHANGE TP-IC.IN PAGE OF 6 th . | |
| F | 2020-03-30 | CHANGE CTP IC to ST1633 | |
| G | 2020-6-24 | Update drawing and add optical data | P5.P6 |
| Н | 2020-07-17 | Update EXTERNAL DIMENSIONS Change the pin4~pin5 definition | P5 P8 |
| I | 2020-08-14 | Change Driver IC Change Power supply input voltage Update EXTERNAL DIMENSIONS | P3 P4 P5 |
| J | 2020-12-07 | Update Interface type; Update CTP DC CHARACTERISTICS; Update TOUCH PANEL CHARACTERISTICS; Update AC CHARACTERISTICS; Update POWER SEQUENCE | P3 P4 P9 P15 |
| к | 2021-03-02 | Update CUSTOMER NO.; Update TP IC; Update EXTERNAL DIMENSIONS; | P3 P5 |
| L | 2021-03-04 | Update Touch Count Max; | P4 |
| М | 2021-10-09 | Update GENERAL INFORMATION ELECTRICAL CHARACTERISTICS EXTERNAL DIMENSIONS | P3 P4 P5 |
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1. GENERAL INFORMATION

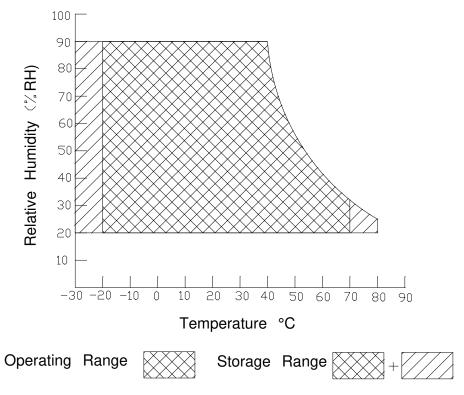
| No. | Item | Contents | Unit |
|-----|--------------------------------|--|------|
| 1 | LCD size | 2.4 inch (Diagonal) | / |
| 2 | Display mode | Normally black/Transmissive/Anti-glare | / |
| 3 | Viewing direction(eye) | FREE | / |
| 4 | Gray scale inversion direction | - | / |
| 5 | Resolution(H*V) | 240 *320 Pixels | / |
| 6 | Module size (L*W*H) | 43.22*60.31*3.93 | mm |
| 7 | Active area (L*W) | 36.72*48.96 | mm |
| 8 | Pixel pitch (L*W) | 0.153*0.153 | mm |
| 9 | Interface type | RGB/MCU/SPI interface | / |
| 10 | Color Depth | 16.7M | / |
| 11 | Module power consumption | 0.51(Appr) | W |
| 12 | Back light type | LED | / |
| 13 | Driver IC | ST7789VI or compatible ST1633I(CTP) | / |
| 14 | Weight | 20.1(Appr) | g |

2. ABSOLUTE MAXIMUM RATINGS

| Item | Symbol | Min. | Max. | Unit | Note |
|------------------------------------|--------|------|---------------|------|-------|
| Power supply input voltage for TFT | VDD | -0.3 | 4.6 | V | |
| Backlight current (normal temp.) | ILED | - | 100 | mA | |
| Operation temperature | Тор | -20 | +70 | °C | Note1 |
| Storage temperature | Tst | -30 | +80 | °C | Note1 |
| Humidity | RH | - | 90%(Max60 °C) | RH | Note1 |

Note1:

The relative humidity and temperature range are as below sketch,90%RH Max.
The maximum wet bulb temperature ≤40°C and without dewing.



3. ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS(at Ta=25°C)

| ltem | Symbol | Min. | Тур. | Max. | Unit | Note |
|----------------------------|--------|----------|------|----------|------|------|
| Power supply input voltage | VCC | 2.4 | 2.8 | 3.6 | V | |
| Input voltage 'H' level | VIH | 0.7VDDIO | - | VDDIO | V | |
| Input voltage 'L' level | VIL | VSS | - | 0.3VDDIO | V | |
| Power supply current | IVDD | - | 9 | - | mA | |

CTP DC CHARACTERISTICS(at Ta=25°C)

| Item | Symbol | Min. | Тур. | Max. | Unit | Note | | |
|---------------------------------|--------|----------|------|----------|------|-------|--|--|
| Power supply input voltage | VCC | 2.8 | 3.3 | 3.6 | V | Note2 | | |
| Input Power ripple | Vpp | - | - | 50 | mV | | | |
| I/O Signal Voltage | VCCIO | 1.6 | - | 3.6 | V | Note2 | | |
| Input voltage 'H' level | VIH | 0.7VCCIO | - | VCCIO | V | | | |
| Input voltage 'L' level | VIL | -0.3 | - | 0.3VCCIO | V | | | |
| Operating Current (Normal Mode) | IVCC | - | 16.1 | 24 | mA | | | |
| Operating Current (Sleep mode) | IVCC | - | - | - | uA | | | |

Note2 : If you need more information of CTP, please refer to our Spec of CTP.

4. BACKLIGHT CHARACTERISTICS

| (a | t 1 | [a=25 | °C,Rł | l=60%) |
|----|-----|-------|-------|--------|
| | | | | |

| Item | Symbol | Min. | Тур. | Max. | Unit | Note |
|-----------------------|--------|------|------------|------|------|-----------|
| LED forward voltage | VF | 5.6 | 6.0 | 6.8 | V | |
| LED forward current | IF | - | 80 | - | mA | IF=20*4mA |
| LED power consumption | PLED | - | 0.48 | - | W | Note1 |
| Number of LED | - | | 4 | | PCS | |
| Connection mode | - | | 4 parallel | | / | |
| LED life-time | - | - | 30000 | - | Hrs | Note2 |

Note1 : Calculator value for reference : IF*VF = PLED

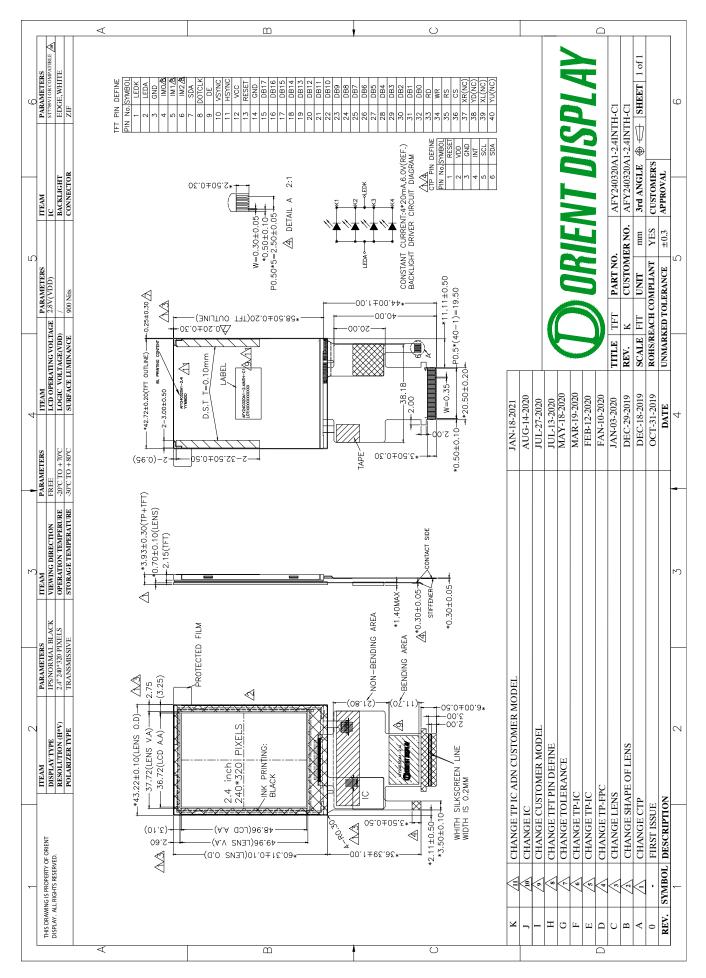
Note2 : The LED life-time define as the estimated time to 50% degradation of initial brightness at Ta=25°C and IF =80mA. The LED lifetime could be decreased if operating IF is larger than 80mA.

5. TOUCH PANEL CHARACTERISTICS

(at Ta=25°C)

| Item | Description | Remark | | | |
|-----------------------|---------------------------------------|------------------------------|--|--|--|
| ProductStructure | G+G | | | | |
| Surface Hardness | ≤6H | Pencil, Loading 500g, 45 deg | | | |
| Ball-falling Test | ≤60cm | Steel ball weight 64g | | | |
| Touch Count Max | Default 2 points, up to Max. 5 points | | | | |
| I2C Slave Address* | 0x70 | | | | |
| Origin of Coordinate* | Top left corner | | | | |

6. EXTERNAL DIMENSIONS



| Item | Symbol | Condition | Min. | Тур. | Max. | Unit | Remark | Note | |
|-------------------------|---------|-----------------|---------------|------|--------------|-------------------|---------|--------|--------|
| Response time | Tr+ Tf | | - | 35 | 45 | ms | FIG.1 | Note 1 | |
| Contrast ratio | Cr | - | 500 | 750 | - | - | FIG.2 | Note 2 | |
| Surface Iuminance | Lv | θ=0° | 600 | 900 | - | cd/m ² | FIG.2 | Note 3 | |
| Luminance uniformity | Yu | θ=0° | 75 | 80 | - | % | FIG.2 | Note 4 | |
| NTSC | - | θ=0° | - | 50 | - | % | FIG.2 | Note 5 | |
| | θ | Ø =90° | 70 | 80 | - | deg | FIG.3 | Note 6 | |
| Viewing angle | | Ø =270° | 70 | 80 | - | deg | FIG.3 | | |
| Viewing angle | | | Ø = 0° | 70 | 80 | - | deg | FIG.3 | Note o |
| | | Ø=180° | 70 | 80 | - | deg | FIG.3 | | |
| | Red x | | | 0.64 | | - | | | |
| | Red y | | | 0.34 | Тур +0.04 | - | | | |
| | Green x | 0.00 | | 0.33 | | - | | | |
| CIE (x,y) | Green y | θ=0° | Тур | 0.61 | | - | FIG.2 | Note 5 | |
| chromaticity | Blue x | Ø=0° Ta=25°C | -0.04 | 0.15 | | - | CIE1931 | | |
| | Blue y | ue y | | 0.06 | | - | | | |
| | White x | | | 0.30 | | - | | | |
| | White y | | | 0.33 | | - | | | |

Note1. Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black"state.Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%. For additional information see FIG1.

Note2.Definition of contrast ratio

Contrast ratio(Cr) is defined mathematically by the following formula.

For more information see FIG.2.

Contrast ratio= <u>Luminance measured when LCD on the "White" state</u> Luminance measured when LCD on the "Black" state

Measured at the center area of the LCD

Note3.Definition of surface luminance

Surface luminance is the luminance with all pixels displaying white.

For more information see FIG.2.

Lv = Average Surface Luminance with all white pixels(P1,P2,P3,,Pn)

Note4.Definition of luminance uniformity

The luminance uniformity in surface luminance is determined by measuring luminance at each test position 1 through n, and then dividing the maximum luminance of n points luminance by minimum luminance of n points luminance.For more information see FIG.2.

 $Yu = \frac{\text{Minimum surface luminance with all white pixels (P1,P2,P3,....,Pn)}{Minimum surface luminance with all white pixels (P1,P2,P3,...,Pn)}$

Maximum surface luminance with all white pixels (P1.P2.P3......Pn)

Note5. Definition of color chromaticity (CIE1931)

CIE (x,y) chromaticity, The x,y value is determined by screen active area center position P5. For more information see FIG.2.

Note6. Definition of viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10. angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG.3.

For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope or DMS series Instruments or compatible. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on TOPCON's BM-5or BM-7 photo detector or compatible.

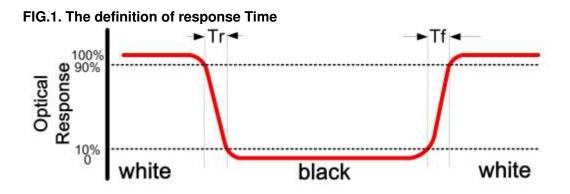


FIG.2. Measuring method for contrast ratio, surface luminance, luminance uniformity, CIE (x,y) chromaticity

H,V : Active area

Light spot size \emptyset =1.5mm (BM-7)50cm distance or compatible distance from the LCM surface to detector lens. Test spot position : see Figure a.

measurement instrument : TOPCON's luminance meter BM-5 or BM-7 or compatible ,see Figure b.

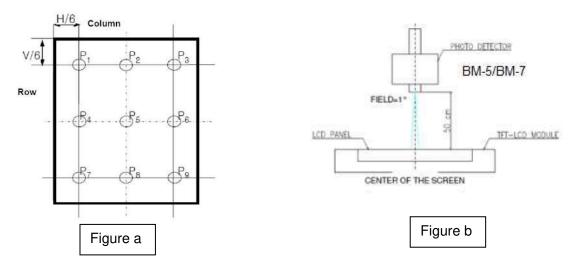
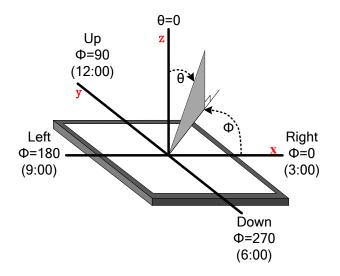


FIG.3. The definition of viewing angle



8. INTERFACE DESCRIPTION

| Module | Interface | description | |
|--------|-----------|-------------|--|
| Module | michacc | acouption | |

| nterface No. | Name | I/O or connect to | Description | | | | | | |
|-----------------|----------------|----------------------|---|----------|----------|---|--------------------------|--|--|
| 1 | LEDK | Р | Power for LED backlight(Cathode). | | | | | | |
| 2 | LEDA | Р | Power for LED backlight(Anode). | | | | | | |
| 3 | GND | Р | Power Ground. | | | | | | |
| 4 | IMO | 1 | IM2 IM1 IM0 MPU Interface Mode Data pin | | | | | | |
| | | | 0 | 0 | 0 | 80-8bit parallel I/F | DB[7:0] | | |
| 5 | IM1 | I | 0 | 0 | 1 | 80-16bit parallel I/F | DB[15:0] | | |
| | | | 0 | 1 | 0 | 80-9bit parallel I/F | DB[8:0] | | |
| 6 | IM2 | I | 1 | 0 | 1 | 80-18bit parallel I/F 3-line 9bit serial I/F | DB[17:0], SDA: in/out | | |
| | | | | | | 2 data lane serial I/F | SDA: in/out WRX: in | | |
| | | | 1 | 1 | 0 | 4-line 8bit serial I/F | SDA: in/out | | |
| 7 | SDA | I/O | SPI in | iterface | input | pin. | - | | |
| 8 | DOTCLK | I | Dot cl | ock. | | | | | |
| 9 | DE | I | Data e | enable. | | | | | |
| 10 | VSYNC | I | Vertic | al sync | input | | | | |
| 11 | HSYNC | I | Horizo | ontal sy | nc inp | ut | | | |
| 12 | VCC | I | Powe | r suppl | y | | | | |
| 13 | RESET | I | Reset | signal | | | | | |
| 14 | GND | I | Powe | r Grour | nd. | | | | |
| 15-32 | DB17DB0 | I/O | Data I | ous (DE | 317D | B0). | | | |
| 33 | RD | I | RGB | Interfac | e.plea | se fix this pin at VDDI o | r DGND. | | |
| 34 | WR | I | RGB | Interfac | e.plea | se fix this pin at VDDI o | r DGND. | | |
| 35 | RS(SCL) | I | RGB | Interfac | e. seri | al interface clock. | | | |
| 36 | CS | I | Chip s | selectio | n pin. I | Low enable. | | | |
| 37 | XR(NC) | / | X-Rig | ht | | | | | |
| 38 | YD(NC) | / | Y-Up | | | | | | |
| 39 | XL(NC) | / | X-Left | t | | | | | |
| 40 | YU(NC) | / | Y-Bott | tom | | | | | |
| | ce description | | | | | | | | |
| terface | Namo | I/O or | | | | Description | | | |

| Interface No. | Name | I/O or connect to | Description |
|------------------|-------|----------------------|------------------------|
| 1 | RESET | I | Reset low |
| 2 | VDD | Р | Power Supply of CTP |
| 3 | GND | Р | Ground |
| 4 | INT | I | State change interrupt |
| 5 | SCL | I | Serial interface clock |
| 6 | SDA | I/O | Serial interface date |

9.AC CHARACTERISTICS Display Parallel 18/16/9/8-bit Interface Timing Characteristics (8080)

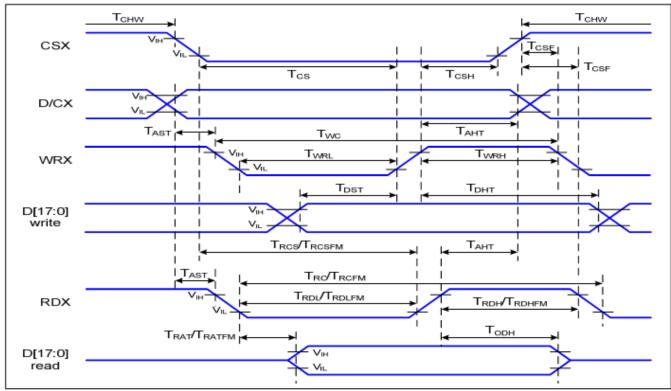


Figure 1 Parallel Interface Timing Characteristics (8080-Series MCU Interface)

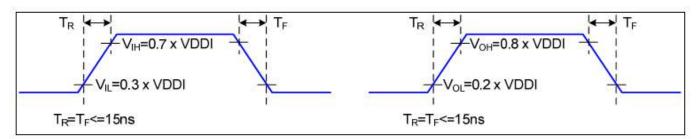


Figure 2 Rising and Falling Timing for I/O Signal

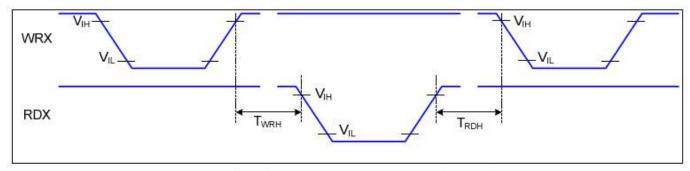
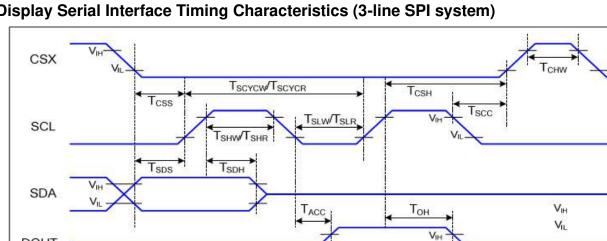


Figure 3 Write-to-Read and Read-to-Write Timing

| Signal | Symbol | Parameter | Min | Max | Unit | Description |
|----------|--------------------|-------------------------------------|-----|-------|------|-------------------|
| D/CX | T _{AST} | T _{AST} Address setup time | | | ns | |
| DICA | T _{AHT} | Address hold time (Write/Read) | 10 | | ns | 170 4 |
| | T _{CHW} | Chip select "H" pulse width | 0 | (3) (| ns | |
| | T _{CS} | Chip select setup time (Write) | 15 | | ns | |
| CSX | T _{RCS} | Chip select setup time (Read ID) | 45 | | ns | 9.41 |
| CSA | T _{RCSFM} | Chip select setup time (Read FM) | 355 | | ns | |
| | T _{CSF} | Chip select wait time (Write/Read) | 10 | | ns | |
| | T _{CSH} | Chip select hold time | 10 | | ns | |
| | T _{WC} | Write cycle | 66 | | ns | |
| WRX | T _{WRH} | Control pulse "H" duration | 15 | | ns | |
| | T _{WRL} | Control pulse "L" duration | 15 | | ns | |
| | T _{RC} | Read cycle (ID) | 160 | | ns | 2 |
| RDX (ID) | T _{RDH} | Control pulse "H" duration (ID) | 90 | | ns | When read ID data |
| | T _{RDL} | Control pulse "L" duration (ID) | 45 | | ns | 4 |
| RDX | T _{RCFM} | Read cycle (FM) | 450 | | ns | When read from |
| (FM) | T _{RDHFM} | Control pulse "H" duration (FM) | 90 | | ns | frame memory |
| (FM) | T _{RDLFM} | Control pulse "L" duration (FM) | 355 | | ns | frame memory |
| D[17:0] | T _{DST} | Data setup time | 10 | | ns | For CL=30pF |
| | T _{DHT} | Data hold time | 10 | | ns | |
| ſ | T _{RAT} | Read access time (ID) | | 40 | ns |] |
| | TRATEM | Read access time (FM) | | 340 | ns |] |
| Γ | TODH | Output disable time | 20 | 80 | ns | |



Display Serial Interface Timing Characteristics (3-line SPI system)

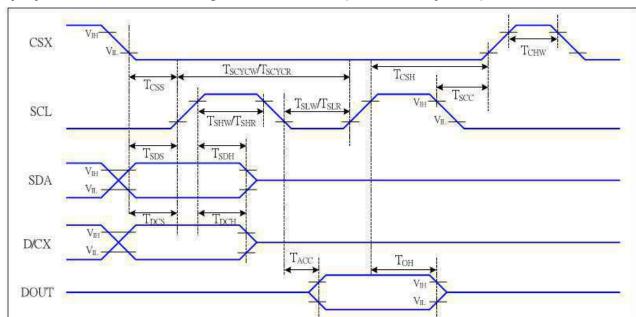
Figure 4 3-line serial Interface Timing Characteristics

VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 to 70 °C

VIL

| Signal | Symbol | Parameter | Min | Max | Unit | Description |
|--------|--------------------|--------------------------------|-----|-----|------|---------------------|
| | T _{CSS} | Chip select setup time (write) | 15 | | ns | |
| | T _{CSH} | Chip select hold time (write) | 15 | | ns | |
| CSX | T _{CSS} | Chip select setup time (read) | 60 | | ns | |
| | T _{SCC} | Chip select hold time (read) | 65 | | ns | |
| | T _{CHW} | Chip select "H" pulse width | 40 | | ns | |
| | T _{SCYCW} | Serial clock cycle (Write) | 66 | | ns | |
| | T _{SHW} | SCL "H" pulse width (Write) | 15 | | ns |] |
| SCL | T _{SLW} | SCL "L" pulse width (Write) | 15 | | ns | |
| SUL | T _{SCYCR} | Serial clock cycle (Read) | 150 | | ns | |
| | T _{SHR} | SCL "H" pulse width (Read) | 60 | | ns | |
| | T _{SLR} | SCL "L" pulse width (Read) | 60 | | ns | |
| SDA | T _{SDS} | Data setup time | 10 | | ns | |
| (DIN) | T _{SDH} | Data hold time | 10 | | ns |] |
| DOUT | T _{ACC} | Access time | 10 | 50 | ns | For maximum CL=30pF |
| DOUT | Тон | Output disable time | 15 | 50 | ns | For minimum CL=8pF |

DOUT



Display Serial Interface Timing Characteristics (4-line SPI system)

Figure 5 4-line serial Interface Timing Characteristics

| Signal | Symbol | Parameter | MIN | MAX | Unit | Description |
|--------|--------------------|--------------------------------|-----|------------|------|-----------------------|
| | T _{CSS} | Chip select setup time (write) | 15 | 28 | ns | |
| | T _{CSH} | Chip select hold time (write) | 15 | 91. S | ns | |
| CSX | T _{CSS} | Chip select setup time (read) | 60 | | ns | |
| | T _{SCC} | Chip select hold time (read) | 65 | | ns | |
| | T _{CHW} | Chip select "H" pulse width | 40 | | ns | |
| | T _{SCYCW} | Serial clock cycle (Write) | 66 | 1 | ns | write command 9 date |
| | T _{SHW} | SCL "H" pulse width (Write) | 15 | 20 | ns | -write command & data |
| SCL | T _{SLW} | SCL "L" pulse width (Write) | 15 | | ns | ram |
| SUL | T _{SCYCR} | Serial clock cycle (Read) | 150 | | ns | and accorded to date |
| | T _{SHR} | SCL "H" pulse width (Read) | 60 | | ns | -read command & data |
| | T _{SLR} | SCL "L" pulse width (Read) | 60 | 50 | ns | ram |
| D/CX | T _{DCS} | D/CX setup time | 10 | 8. · · · · | ns | |
| DICX | T _{DCH} | D/CX hold time | 10 | | ns | |
| SDA | T _{SDS} | Data setup time | 10 | | ns | |
| (DIN) | T _{SDH} | Data hold time | 10 | | ns | |
| DOUT | T _{ACC} | Access time | 10 | 50 | ns | For maximum CL=30pF |
| DOUT | Тон | Output disable time | 15 | 50 | ns | For minimum CL=8pF |

VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 to 70 C

RGB Interface Characteristics

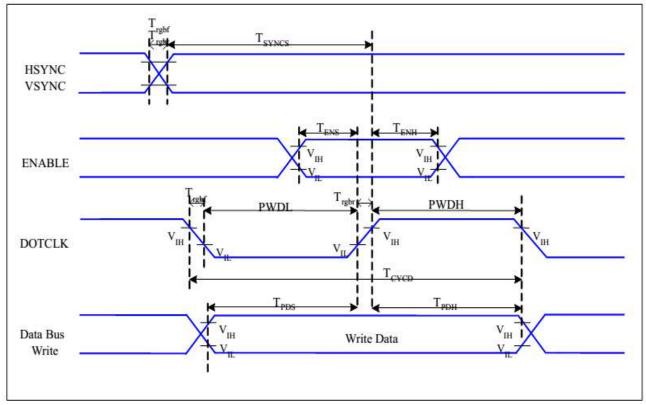
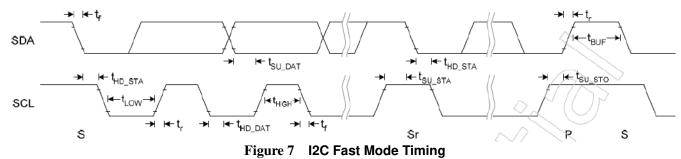


Figure 6 RGB Interface Timing Characteristics

VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 ~ 70 °C

| Signal | Symbol | Parameter | MIN | MAX | Unit | Description |
|-----------------|-------------------|-------------------------------|-----|-----|------|-------------|
| HSYNC, VSYNC | | VSYNC, HSYNC Setup Time | 30 | - | ns | |
| ENABLE | T _{ENS} | Enable Setup Time | 25 | 121 | ns | |
| ENADLE | T _{ENH} | Enable Hold Time | 25 | - | ns | |
| | PWDH | DOTCLK High-level Pulse Width | 60 | | ns | |
| DOTCLK | PWDL | DOTCLK Low-level Pulse Width | 60 | | ns | |
| DUTCLK | T _{CYCD} | DOTCLK Cycle Time | 120 | | ns | |
| 8 | Trghr, Trghf | DOTCLK Rise/Fall time | - | 20 | ns | - |
| DB | T _{PDS} | PD Data Setup Time | 50 | | ns | |
| | T _{PDH} | PD Data Hold Time | 50 | | ns | |

CTP AC CHARACTERISTICS



| | Parameter | | Rating | | | |
|-------------------------|---|--------------|--------|--------------|------|--|
| Symbol | | | Typ. | Max. | Unit | |
| f _{SCL} | SCL clock frequency | 0 | \sim | 400 | kHz | |
| t _{LOW} | Low period of the SCL clock | 1.3 | JF | (<u>1</u>) | us | |
| t _{HIGH} | High period of the SCL clock | 0.6 | P. | | us | |
| t _f | Signal falling time | | | 300 | ns | |
| tr | Signal rising time | < | 124 | 300 | ns | |
| t _{su_sta} | Set up time for a repeated START condition | 0.6 | - | - | us | |
| t _{hd_sta} | Hold time (repeated) START condition. After this period, the first clock pulse is generated | 0.6 | - | | us | |
| t _{SU DAT} | Data set up time | 100 | - | | ns | |
| t _{HD DAT} | Data hold time | 0 | | 0.9 | us | |
| t _{su sto} | Set up time for STOP condition | 0.6 | | | us | |
| t _{BUF} | Bus free time between a STOP and START condition | 1.3 | - | - | us | |
| Cb | Capacitive load for each bus line | 5 <u>-</u> 5 | 128 | 400 | pF | |

Conditions: VDD = 3.3V, GND = 0V, $T_{A} = 25^{\circ}C$

10.POWER SEQUENCE

10.1 TFT Power On/Off Sequence

VDDI and VDD can be applied in any order.

VDD and VDDI can be power down in any order.

During power off, if LCD is in the Sleep Out mode, VDD and VDDI must be powered down minimum 120msec after RESX has been released.

During power off, if LCD is in the Sleep In mode, VDDI or VDD can be powered down minimum 0msec after

RESX has been released.

CSX can be applied at any timing or can be permanently grounded. RESX has priority over CSX.

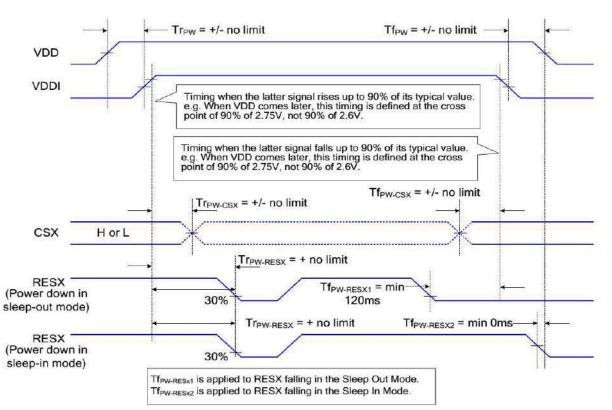
Note 1: There will be no damage to the display module if the power sequences are not met.

Note 2: There will be no abnormal visible effects on the display panel during the Power On/Off Sequences.

Note 3: There will be no abnormal visible effects on the display between end of Power On Sequence and before receiving Sleep Out command. Also between receiving Sleep In command and Power Off Sequence.

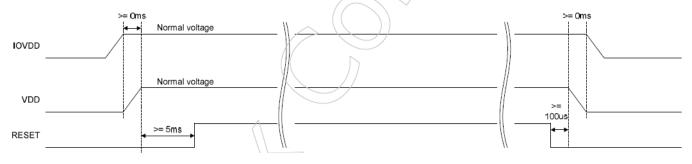
Note 4: If RESX line is not held stable by host during Power On Sequence as defined in the sequence below, then it will be necessary to apply a Hardware Reset (RESX) after Host Power On Sequence is complete to ensure correct operation. Otherwise function is not guaranteed.

The power on/off sequence is illustrated below



10.2 CTP Power On/Off Sequence

RESET pin should be held low before power on and power off. During power on, after both VDD and IOVDD reach normal voltage, RESET pin needs to be held low for 5ms to ensure internal block stable.



11. RELIABILITY TEST CONDITIONS

| No. | Test item | Test con | Inspection after test | |
|------|-------------------------------------|--|-------------------------------|--|
| 11.1 | High temperature storage test | +80°C/240 hours | | |
| 11.2 | Low temperature storage test | -30°C/240 hours | | |
| 11.3 | High temperature operating test | +70°C/120 hours | | |
| 11.4 | Low temperature operating test | -20°C/120 hours | | Inspection after 2~4hours storage at |
| 11.5 | Temperature cycle storage test | | -30°C ~ 25°C ~ +80°C/10cycles | |
| 11.6 | High temperature high humidity test | +50°C*90% RH/120 hours | | sample shall be free from defects : 1.Current changing |
| 11.7 | Vibration test | Frequency : 250 r/min Amplitude : 1 inch Time: 45min | | value before test and after test is 50% larger; 2. Function defect : |
| | | Drop direction: 1 corner/3 edges/6 sides 10 times | | Non-display,abnormal-d isplay,missing lines, Short lines,ITO |
| | | Packing weight(kg) | Drop height(cm) | corrosion; |
| 11.8 | Drop test | <11 | 80±1.6 | 3.Visual defect : Air bubble in the LCD,Seal |
| 11.0 | | 11≦G<21 | 60±1.2 | leak,Glass crack. |
| | | 21≦G<31 | 50±1.0 | |
| | | 31≦G<40 | 40±0.8 | |
| 11.9 | ESD test | Air discharge: ±8KV, 10times Contact discharge: ±4KV, 10times | | |

Remark :

1. The test samples should be applied to only one test item.

2.Sample size for each test item is 3~5pcs.

3.For High temperature high humidity test, Pure water(Resistance>10MΩ) should be used.

4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.

5.B/L evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence B/L has. 6.Failure judgment criterion: Basic specification, Electrical characteristic, Mechanical characteristic, Optical characteristic.

7.After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.

12. INSPECTION CRITERION

Refer to Inspection Criterion of back specification

13. HANDLING PRECAUTIONS

13.1 Mounting method

The LCD module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board. Extreme care should be needed when handling the LCD modules.

13.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[recommended below] and wipe lightly :

- •.lsopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

- Do not use the following solvent :
- Water

Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated :

Soldering flux

•.Chlorine (Cl) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

13.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you :

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

13.4 Packing

Module employ LCD elements and must be treated as such.

•.Avoid intense shock and falls from a height.

•. To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity.

13.5 Caution for operation

•. It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.

•. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.

•.Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.

•. If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.

•.A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

•.Usage under the maximum operating temperature, 50%Rh or less is required.

•. When fixed patterns are displayed for a long time, remnant image is likely to occur.

13.6 Storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

•.Storing in an ambient temperature 10°C to 30°C, and in a relative humidity of 45% to 75%. Don't expose to sunlight or fluorescent light.

•. Storing in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it . And with no desiccant.

•.Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.

•.Storing with no touch on polarizer surface by the anything else.

It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

13.7 Safety

•. It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by

either of solvents such as acetone and ethanol, which should be burned up later.

•. When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

14. PRECAUTION FOR USE

14.1 A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

14.2 On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- •.When a question is arisen in this specification.
- •.When a new problem is arisen which is not specified in this specifications.

•.When an inspection specifications change or operating condition change in customer is reported to ODNA, and some problem is arisen in this specification due to the change.

•.When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

15. PACKING SPECIFICATION

Please consult our technical department for detail information.

16. INITIALIZATION CODE

Void Vendor X panelinitialcode(void) LCD RESET=1; Delayms(1); //Delay 1ms LCD_RESET=0; Delayms(10); //Delay 10ms LCD RESET=1; Delayms(120): //Delay 120ms write cmd(0x11); //SLPOUT (11h): Sleep Out Delayms(120); //Delay 120ms write cmd(0x36); //MADCTL (36h): Memory Data Access Control - Default write dat(0x00); write_cmd(0x3A); //COLMOD (3Ah): Interface Pixel Format write dat(0x05); write cmd(0xB2); //PORCTRL (B2h): Porch Setting - Default write dat(0x0C); write dat(0x0C); write dat(0x00); write dat(0x33); write dat(0x33); write cmd(0xB7); //GCTRL (B7h): Gate Control write dat(0x75); write_cmd(0xBB);//VCOMS (BBh): VCOM Setting write dat(0x13); write_cmd(0xC0); //LCMCTRL (C0h): LCM Control - Default write dat(0x2C); write cmd(0xC2)://VDVVRHEN (C2h): VDV and VRH Command Enable - Default write dat(0x01); write cmd(0xC3);//VRHS (C3h): VRH Set write dat(0x13); write cmd(0xC4);//VDVS (C4h): VDV Set - Default write dat(0x20); write_cmd(0xC6); //FRCTRL2 (C6h): Frame Rate Control in Normal Mode - Default write dat(0x0F); write cmd(0xD0);//PWCTRL1 (D0h): Power Control 1 - Default write dat(0xA4); write dat(0xA1); write cmd(0xD6);//Undocumented write dat(0xA1); write cmd(0x21); //INVON (21h): Display Inversion On write cmd(0xE0); //PVGAMCTRL (E0h): Positive Voltage Gamma Control write_dat(0xD0); write_dat(0x08); write dat(0x10); write_dat(0x0D); write dat(0x0C); write dat(0x07): write dat(0x37); write dat(0x53); write dat(0x4C); write_dat(0x39); write_dat(0x15); write_dat(0x15); write dat(0x2A); write dat(0x2D); write_cmd(0xE1); //NVGAMCTRL (E1h): Negative Voltage Gamma Control write dat(0xD0); write dat(0x0D); write dat(0x12); write dat(0x08); write dat(0x08); write_dat(0x15);

write_dat(0x34); write_dat(0x34); write_dat(0x34); write_dat(0x36); write_dat(0x12); write_dat(0x12); write_dat(0x2B); write_dat(0x2F); write_cmd(0x29); //DISPON (29h): Display On }

17. HSF COMPLIANCE

•.This products complies with ROHS 2011/65/EU and 2015/863/EU、REACH 1907/2006/EC requirements, and the packaging complies with 94-62-EC.